

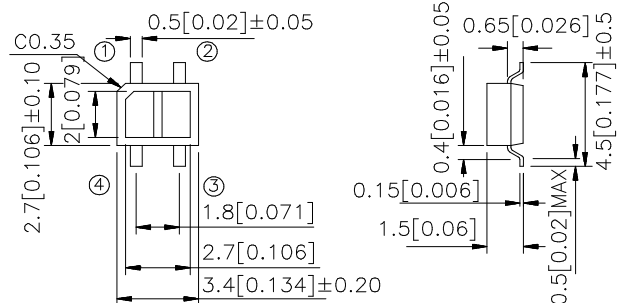
## SUBMINIATURE, HIGH SENSITIVITY PHOTOINTERRUPTER

### \*Features

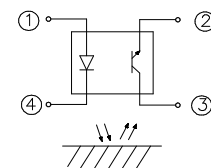
- Compact and thin.
- Visible light cut-off type.
- High sensitivity.
- Package:1000pcs/Reel.
- RoHS Compliant.

### \*Applications

- Cassette tape recorders,VCRs.
- Floppy disk drives.
- Various microcomputerized control equipment.



- ① Anode    ② Emitter  
③ Collector ④ Cathode



UNIT : MM[INCH]

TOLERANCE :±0.25[± 0.01] UNLESS OTHERWISE NOTED.

### \*Absolute Maximum Ratings

Parameter		Symbol	Rating	Unit
Input	Forward current	$I_F$	50	mA
	Reverse voltage	$V_R$	6	V
	Power dissipation	$P_d$	75	mW
	Peak Forward Current (Pulse Width $\leq 100\mu\text{s}$ , Duty Cycle =1%)	$I_{FP}$	1	A
Output	Collector-emitter voltage	$V_{CEO}$	35	V
	Emitter-collector voltage	$V_{ECO}$	6	V
	Collector current	$I_C$	20	mA
	Collector power dissipation	$P_C$	75	mW
Operating temperature		$T_{opr}$	-25~+85	°C
Storage temperature		$T_{stg}$	-40~+100	°C
soldering temperature (1/16 inch from body for 5 seconds)		$T_{sol}$	260	°C

## ■ Electro-optical Characteristics

Parameter		Symbol	Conditions	Min.	TYP.	Max.	Unit	
Input	Forward Voltage	$V_F$	$I_F=20\text{mA}$	1.0	1.2	1.5	V	
	Reverse Current	$I_R$	$V_R=6\text{V}$	-	-	10	$\mu\text{A}$	
	Peak Wavelength	$\lambda_P$	$I_F=20\text{mA}$	-	940	-	nm	
Output	Collector Dark Current	$I_{CEO}$	$V_{CE}=20\text{V}$	-	$10^{-9}$	$10^{-7}$	A	
Transfer characteristics	*1 Collector Current		$I_C$	$V_{CE}=2\text{V}$ $I_F=4\text{mA}$	10	-	400	$\mu\text{A}$
	*2 Leak Current		$I_{LEAK}$	$V_{CE}=2\text{V}$ $I_F=4\text{mA}$	-	-	0.1	$\mu\text{A}$
	Response time	Rise time	$t_r$	$V_{CE}=2\text{V}$ $I_C=100\mu\text{A}$ $R_L=1\text{K}\Omega, d=1\text{mm}$	-	20	100	$\mu\text{sec}$
		Fall time	$t_f$		-	20	100	$\mu\text{sec}$

\*1 The condition and arrangement of the reflective object are shown below.  
 \*2 Without reflective object.

## ■ Classification table of radiant flux

Rank mark	E	F	G
$I_C (\mu\text{A})$	10~120	100~250	200~400

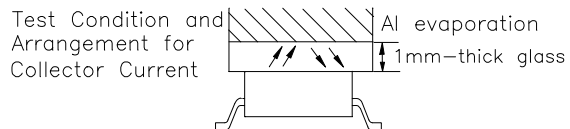


Fig. 1 Forward Current vs. Forward Voltage

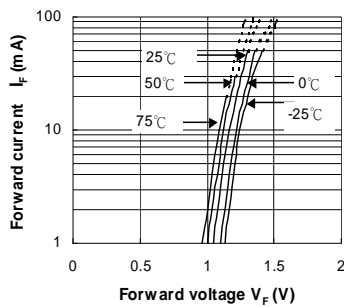


Fig. 2 Collector Current vs. Forward Current

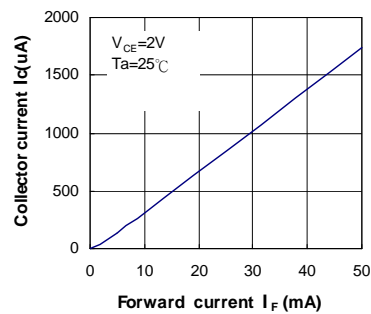


Fig. 3 Collector Current vs. Collector-emitter Voltage

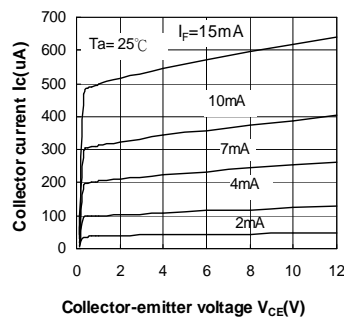


Fig. 4 Relative Collector Current vs. Ambient Temperature

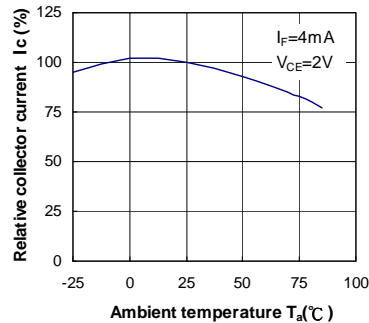
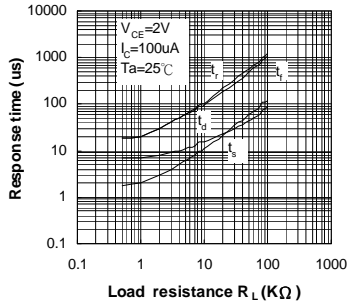


Fig. 5 Response Time vs. Load Resistance



Test Circuit for Response Time

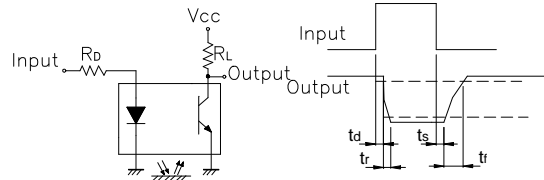


Fig. 6 Collector Dark Current vs. Ambient Temperature

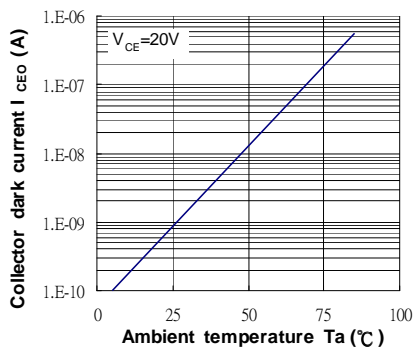


Fig. 7 Relative Collector Current vs. Distance between Sensor and Al Evaporation Glass

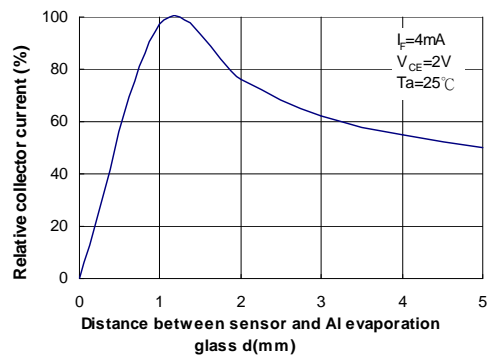


Fig. 8 Relative Collector Current vs. Card Moving Distance (1)

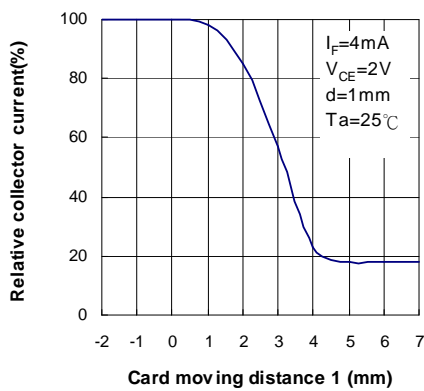
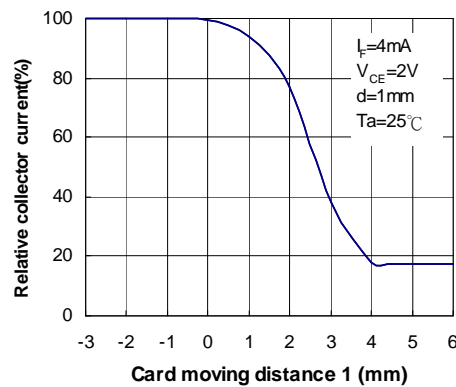
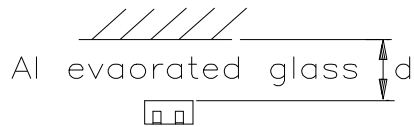


Fig. 9 Relative Collector Current vs. Card Moving Distance (2)



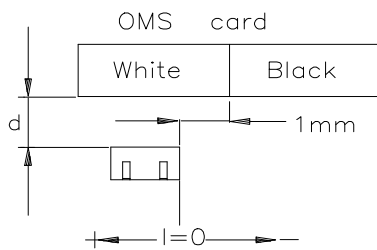
## Test Condition for Distance & Detecting Position Characteristics

Correpond to Fig. 7



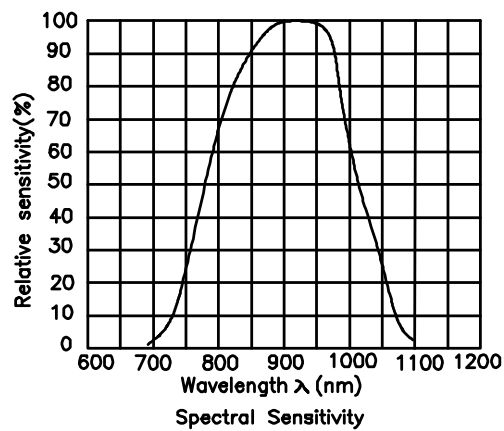
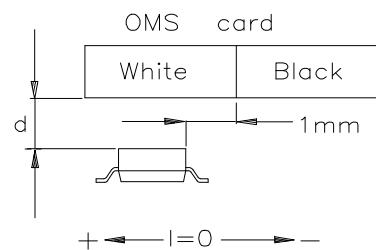
Correpond to Fig. 8  
Test condition

$I_F = 4\text{mA}$   
 $V_{CE} = 2\text{V}$   
 $d = 1\text{mm}$



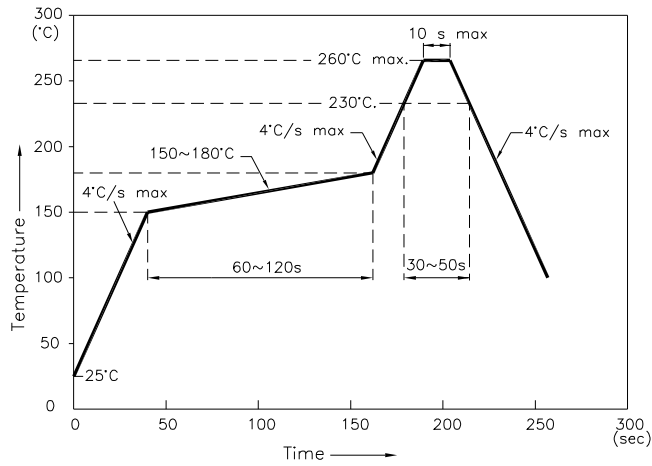
Correpond to Fig. 9  
Test condition

$I_F = 4\text{mA}$   
 $V_{CE} = 2\text{V}$   
 $d = 1\text{mm}$



**ATIR0711S**

Reflow Soldering Profile For Lead-free SMT Process.

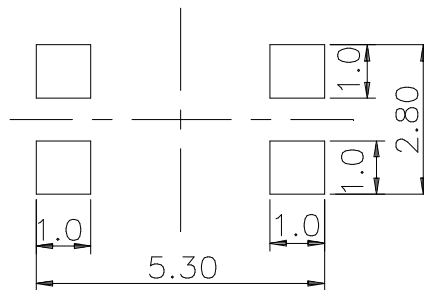


NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

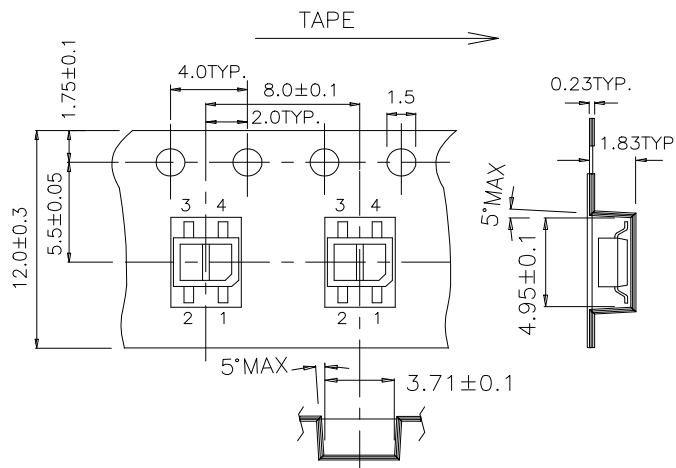
**Recommended Soldering Pattern**

(Units : mm)



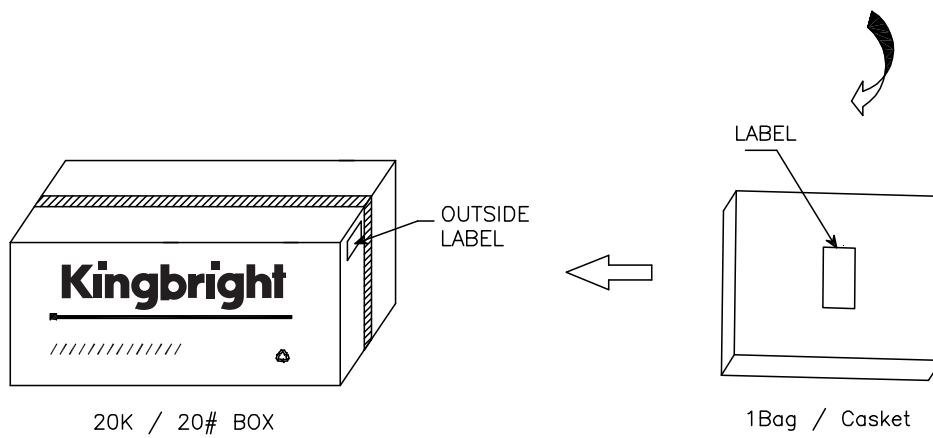
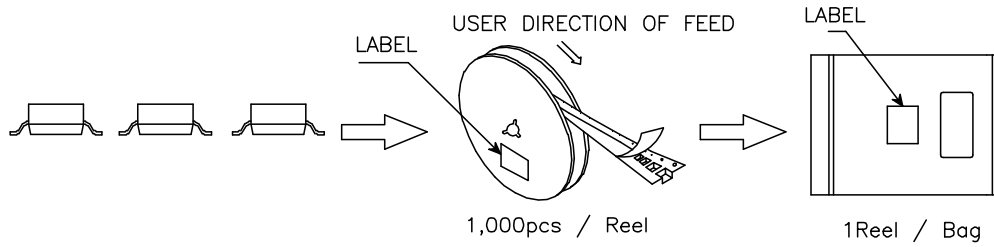
**Tape Specifications**

(Units : mm)



PACKING & LABEL SPECIFICATIONS

ATIR0711S



<h2 style="margin: 0;">Kingbright</h2>	
P/NO: . ATIR0711S	
QTY: 1,000 pcs	Q.C.
S/N: XXXX	<div style="border: 1px solid black; border-radius: 50%; padding: 5px; display: inline-block;">             Q C              xx xx. xxxx              PASSED           </div>
CODE: XX	Date _____
LOT NO:	
MADE IN CHINA	RoHS Compliant